

Stepping Motor Driver Series

Standard 36V Stepping Motor Drivers



BD63940EFV, BD63960EFV

No.12009EAT11

●Description

BD63940EFV, BD63960EFV are the ultra simple type that provides the minimum function for driving stepping motor and various protection circuits.

As for its basic function, it is a low power consumption bipolar PWM constant current-drive driver with power supply's rated voltage of 36V and rated output current of 1.2A, 1.5A, and each driver is pin-compatible so that replacement can be done easily. Also it makes μ -STEP drive possible by inputting external DAC signal so that it provides wider application area. There are excitation modes of FULL STEP & HALF STEP mode. This series contributes to reduction of mounting area, cost down, safety design.

●Feature

- 1) Power supply: one system drive (rated voltage of 36V)
- 2) Rated output current: 1.2A, 1.5A
- 3) Low ON resistance DMOS output
- 4) Parallel IN drive mode
- 5) 2ch drive DC motor
- 6) PWM constant current control (self oscillation)
- 7) Built-in spike noise cancel function (external noise filter is unnecessary)
- 8) FULL STEP applicable to HALF STEP
- 9) Applicable to μ step drive
- 10) Forward/reverse break mode for DC motor
- 11) Power save function
- 12) Built-in logic input pull-down resistor
- 13) Power-on reset function
- 14) Thermal shutdown circuit (TSD)
- 15) Over current protection circuit (OCP)
- 16) Under voltage lock out circuit (UVLO)
- 17) Over voltage lock out circuit (OVLO)
- 18) Malfunction prevention at the time of no applied power supply (Ghost Supply Prevention)
- 19) Electrostatic discharge: 4kV (HBM specification)
- 20) Microminiature, ultra-thin and high heat-radiation (exposed metal type) HTSSOP package
- 21) Pin-compatible line-up

●Application

Laser beam printer, Scanner, Photo printer, FAX, Ink jet printer, Mini printer, Sewing machine, Toy, and Robot etc.

●Absolute maximum ratings(Ta=25°C)

Item	Symbol	BD63940EFV	BD63960EFV	Unit
Supply voltage	V _{CC1,2}	-0.2~+36.0		V
Power dissipation	Pd	1.1※ ¹		W
		4.0※ ²		
Input voltage for control pin	V _{IN}	-0.2~+5.5		V
RNF maximum voltage	V _{RNF}	0.5		V
Maximum output current	I _{OUT}	1.2※ ³	1.5※ ³	A/phase
Operating temperature range	T _{opr}	-25~+85		°C
Storage temperature range	T _{stg}	-55~+150		°C
Junction temperature	T _{jmax}	+150		°C

※1 70mm × 70mm × 1.6mm glass epoxy board. Derating in done at 8.8mW/°C for operating above Ta=25°C.

※2 4-layer recommended board. Derating in done at 32.0mW/°C for operating above Ta=25°C.

※3 Do not, however exceed Pd, ASO and Tjmax=150°C.

●Operating conditions(Ta= -25~+85°C)

Item	Symbol	BD63940EFV	BD63960EFV	Unit
Supply voltage	V _{CC1,2}	19~28		V
Output current (DC)	I _{OUT}	0.9 ^{※4}	1.2 ^{※4}	A/phase

※4 Do not however exceed Pd, ASO.

●Electrical characteristics

Applicable to all the series (Unless otherwise specified Ta=25°C, V_{cc1,2}=24V)

Item	Symbol	Limit			Unit	Condition
		Min.	Typ.	Max.		
Whole						
Circuit current at standby	I _{CCST}	-	0.6	2.0	mA	PS=L
Circuit current	I _{CC}	-	2.7	7.0	mA	PS=H, VREF=0.4V
Control input (IN1A, IN1B, IN2A, IN2B, PS)						
H level input voltage	V _{INH}	2.0	-	-	V	
L level input voltage	V _{INL}	-	-	0.8	V	
Output (OUT1A, OUT1B, OUT2A, OUT2B)						
Output ON resistance (BD63940EFV)	R _{ON}	-	1.4	1.8	Ω	I _{OUT} =0.7A Sum of upper and lower
Output ON resistance (BD63960EFV)	R _{ON}	-	1.1	1.4	Ω	I _{OUT} =1.0A Sum of upper and lower
Output leak current	I _{LEAK}	-	-	10	μA	
Current control						
RNFX input current	I _{RNFX}	-40	-20	-	μA	RNFX=0V
VREFX input current	I _{VREF}	-2.0	-0.1	-	μA	VREFX=0V
VREFX input voltage range	V _{REF}	0	-	0.4	V	
Comparator offset	V _{COFS}	-20	0	20	mV	VREFX=0.4V
Minimum on time	T _{ONMIN}	0.3	0.7	1.2	μs	R=39kΩ, C=1000pF

● Terminal function

1) BD63940EFV/BD63960EFV

Pin No.	Pin name	Function	Pin No.	Pin name	Function
1	PGND	Ground terminal	13	IN1A	Logic input terminal
2	IN2B	Logic input terminal	14	PGND	Ground terminal
3	VREF2	Output current value setting terminal	15	VCC1	Power supply terminal
4	CR2	Connection terminal of CR for setting PWM frequency	16	OUT1A	H bridge output terminal
5	NC	Non connection	17	RNF1	Connection terminal of resistor for output current detection
6	TEST	Terminal for testing (used by connecting with GND)	18	OUT1B	H bridge output terminal
7	GND	Ground terminal	19	OUT2B	H bridge output terminal
8	PS	Power save terminal	20	RNF2	Connection terminal of resistor for output current detection
9	CR1	Connection terminal of CR for setting PWM frequency	21	OUT2A	H bridge output terminal
10	VREF1	Output current value setting terminal	22	VCC2	Power supply terminal
11	IN1B	Logic input terminal	23	NC	Non connection
12	NC	Non connection	24	IN2A	Logic input terminal

● Block diagram · Application circuit diagram · Input output equivalent circuit diagram

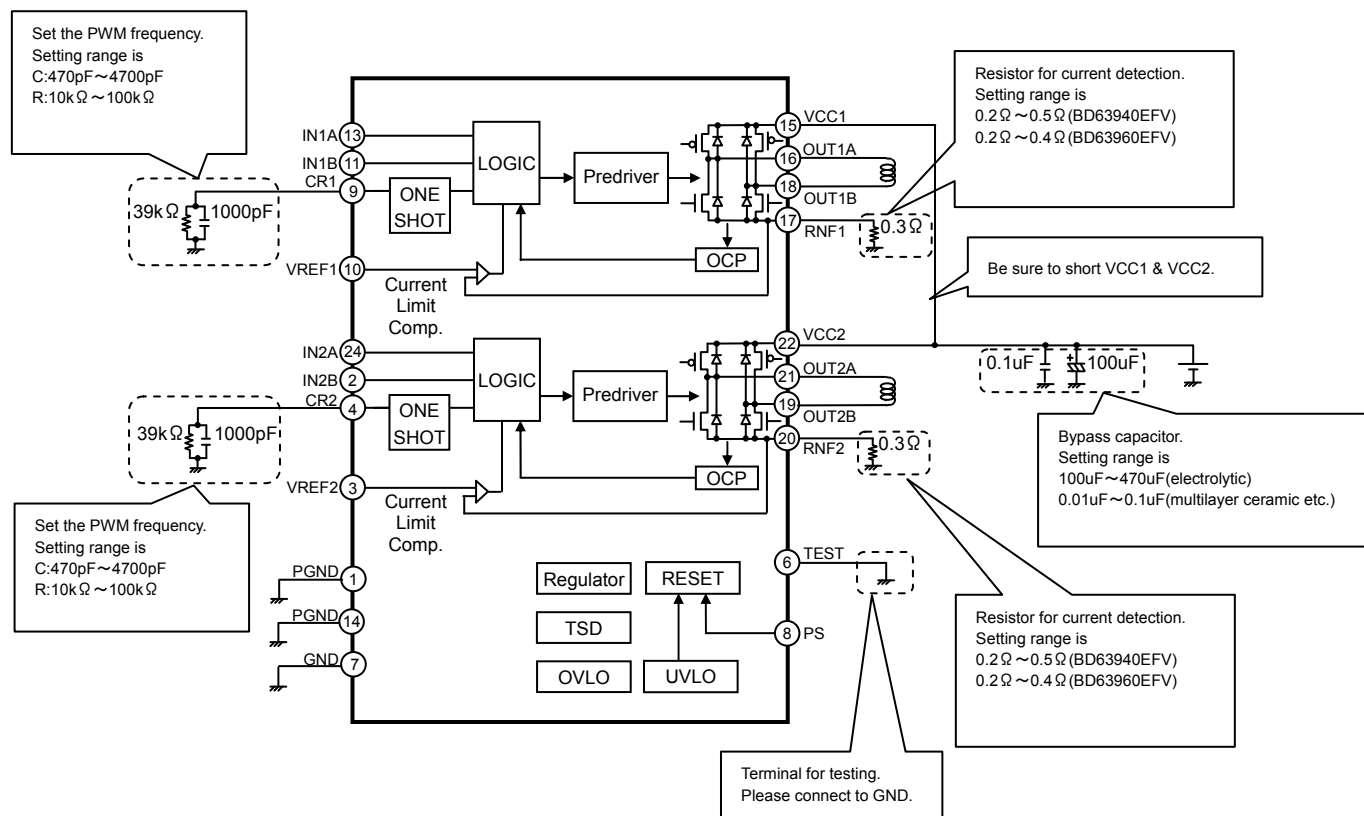


Fig.1 Block diagram & Application circuit diagram

●Points to notice for terminal description

○PS/Power save terminal

PS can make circuit standby state and make motor output OPEN. Please be careful because there is a delay of 40μs(max.) before it is returned from standby state to normal state and the motor output becomes ACTIVE.

PS	State
L	Standby state (RESET)
H	ACTIVE

○IN1A, IN1B, IN2A, IN2B/Control logic input terminal

These terminals decide output state.

PS	Input		Output		
	IN1A IN2A	IN1B IN2B	OUT1A OUT2A	OUT1B OUT2B	
L	X	X	OPEN	OPEN	Stand by (All circuits)
H	L	L	OPEN	OPEN	Stand by
H	H	L	H	L	Forward
H	L	H	L	H	Reverse
H	H	H	L	L	Brake

X: H or L

●Protection Circuits

○Thermal Shutdown (TSD)

This IC has a built-in thermal shutdown circuit for thermal protection. When the IC's chip temperature rises above 175°C (Typ.), the motor output becomes OPEN. Also, when the temperature returns to under 150°C (Typ.), it automatically returns to normal operation. However, even when TSD is in operation, if heat is continued to be added externally, heat overdrive can lead to destruction.

○Over Current Protection (OCP)

This IC has a built in over current protection circuit as a provision against destruction when the motor outputs are shorted each other or Vcc-motor output or motor output-GND is shorted. This circuit latches the motor output to OPEN condition when the regulated threshold current flows for 4μs (Typ.). It returns with power reactivation or a reset of the PS terminal. The over current protection circuit's only aim is to prevent the destruction of the IC from irregular situations such as motor output shorts, and is not meant to be used as protection or security for the set. Therefore, sets should not be designed to take into account this circuit's functions. After OCP operating, if irregular situations continues and the return by power reactivation or a reset of the PS terminal is carried out repeatedly, then OCP operates repeatedly and the IC may generate heat or otherwise deteriorate. When the L value of the wiring is great due to the wiring being long, after the over current has flowed and the output terminal voltage jumps up and the absolute maximum values may be exceeded and as a result, there is a possibility of destruction. Also, when current which is over the output current rating and under the OCP detection current flows, the IC can heat up to over $T_{jmax} = 150^{\circ}\text{C}$ and can deteriorate, so current which exceeds the output rating should not be applied.

○Under Voltage Lock Out (UVLO)

This IC has a built-in under voltage lock out function to prevent false operation such as IC output during power supply under voltage. When the applied voltage to the Vcc terminal goes under 15V (Typ.), the motor output is set to OPEN. This switching voltage has a 1V (Typ.) hysteresis to prevent false operation by noise etc. Please be aware that this circuit does not operate during power save mode.

○Over Voltage Lock Out (OVLO)

This IC has a built-in over voltage lock out function to protect the IC output and the motor during power supply over voltage. When the applied voltage to the VCC terminal goes over 32V (Typ.), the motor output is set to OPEN. This switching voltage has a 1V (Typ.) hysteresis and a 4μs (Typ.) mask time to prevent false operation by noise etc. Although this over voltage locked out circuit is built-in, there is a possibility of destruction if the absolute maximum value for power supply voltage is exceeded, therefore the absolute maximum value should not be exceeded. Please be aware that this circuit does not operate during power save mode.

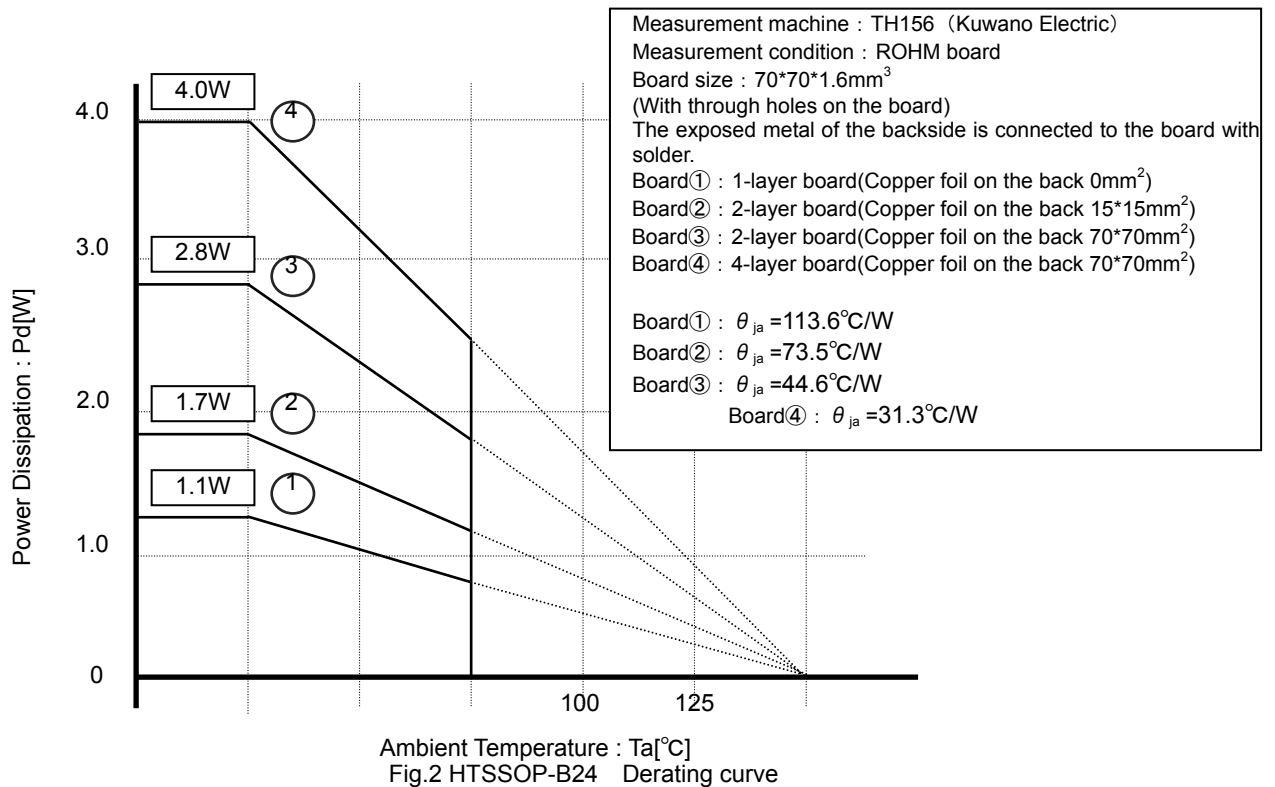
○False operation prevention function in no power supply (Ghost Supply Prevention)

If a logic control signal is input when there is no power supplied to this IC, there is a function which prevents the false operation by voltage supplied via the electrostatic destruction prevention diode from the logic control input terminal to the Vcc, to this IC or to another IC's power supply. Therefore, there is no malfunction of the circuit even when voltage is supplied to the logic control input terminal while there is no power supply.

●Power dissipation

○HTSSOP-B24 Package (BD63940EFV/BD63960EFV))

HTSSOP-B24 has exposed metal on the back, and it is possible to dissipate heat from a through hole in the back. Also, the back of board as well as the surfaces has large areas of copper foil heat dissipation patterns, greatly increasing power dissipation. The back metal is shorted with the back side of the IC chip, being a GND potential, therefore there is a possibility for malfunction if it is shorted with any potential other than GND, which should be avoided. Also, it is recommended that the back metal is soldered onto the GND to short. Please note that it has been assumed that this product will be used in the condition of this back metal performed heat dissipation treatment for increasing heat dissipation efficiency.



● Usage Notes

(1) Absolute maximum ratings

An excess in the absolute maximum ratings, such as supply voltage, temperature range of operating conditions, etc., can break down the devices, thus making impossible to identify breaking mode, such as a short circuit or an open circuit. If any over rated values will expect to exceed the absolute maximum ratings, consider adding circuit protection devices, such as fuses.

(2) Connecting the power supply connector backward

Connecting of the power supply in reverse polarity can damage IC. Take precautions when connecting the power supply lines. An external direction diode can be added.

(3) Power supply Lines

Design PCB layout pattern to provide low impedance GND and supply lines. To obtain a low noise ground and supply line, separate the ground section and supply lines of the digital and analog blocks. Furthermore, for all power supply terminals to ICs, connect a capacitor between the power supply and the GND terminal. When applying electrolytic capacitors in the circuit, not that capacitance characteristic values are reduced at low temperatures.

(4) GND Potential

The potential of GND pin must be minimum potential in all operating conditions.

(5) Metal on the backside (Define the side where product markings are printed as front)

The metal on the backside is shorted with the backside of IC chip therefore it should be connected to GND. Be aware that there is a possibility of malfunction or destruction if it is shorted with any potential other than GND.

(6) Thermal design

Use a thermal design that allows for a sufficient margin in light of the power dissipation (P_d) in actual operating conditions. Users should be aware that this series has been designed to expose their frames at the back of the package, and should be used with suitable heat dissipation treatment in this area to improve dissipation. As large a dissipation pattern should be taken as possible, not only on the front of the baseboard but also on the back surface.

(7) Mounting errors and inter-pin shorts

When attaching to a printed circuit board, pay close attention to the direction of the IC and displacement. Improper attachment may lead to destruction of the IC. There is also possibility of destruction from short circuits which can be caused by foreign matter entering between outputs or an output and the power supply or GND.

(8) Operation in a strong electric field

Use caution when using the IC in the presence of a strong electromagnetic field as doing so may cause the IC to malfunction.

(9) ASO

When using the IC, set the output transistor so that it does not exceed absolute maximum ratings or ASO.

(10) Thermal shutdown circuit

The IC has a built-in thermal shutdown circuit (TSD circuit). If the chip temperature becomes $T_{jmax} = 150^\circ\text{C}$, and higher, coil output to the motor will be open. The TSD circuit is designed only to shut the IC off to prevent runaway thermal operation. It is not designed to protect or indemnify peripheral equipment. Do not use the TSD function to protect peripheral equipment.

TSD on temperature [$^\circ\text{C}$] (Typ.)	Hysteresis Temperature [$^\circ\text{C}$] (Typ.)
175	25

(11) Inspection of the application board

During inspection of the application board, if a capacitor is connected to a pin with low impedance there is a possibility that it could cause stress to the IC, therefore an electrical discharge should be performed after each process. Also, as a measure against electrostatic discharge, it should be earthed during the assembly process and special care should be taken during transport or storage. Furthermore, when connecting to the jig during the inspection process, the power supply should first be turned off and then removed before the inspection.

(12) Input terminal of IC

This IC is a monolithic IC, and between each element there is a P+ isolation for element partition and a P substrate. This P layer and each element's N layer make up the P-N junction, and various parasitic elements are made up. For example, when the resistance and transistor are connected to the terminal as shown in figure 3,

○When $GND > (\text{Terminal A})$ at the resistance and $GND > (\text{Terminal B})$ at the transistor (NPN), the P-N junction operates as a parasitic diode.

○Also, when $GND > (\text{Terminal B})$ at the transistor (NPN)

The parasitic NPN transistor operates with the N layers of other elements close to the aforementioned parasitic diode.

Because of the IC's structure, the creation of parasitic elements is inevitable from the electrical potential relationship. The operation of parasitic elements causes interference in circuit operation, and can lead to malfunction and destruction. Therefore, be careful not to use it in a way which causes the parasitic elements to operate, such as by applying voltage that is lower than the GND (P substrate) to the input terminal.

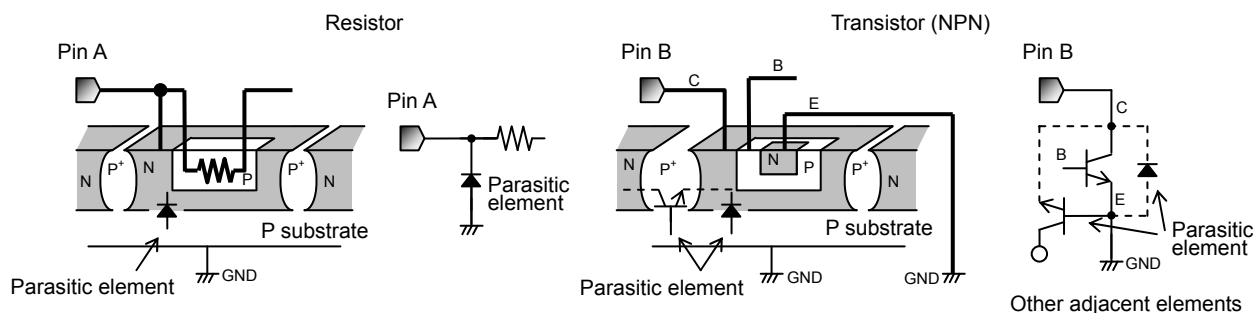


Fig.3 Pattern Diagram of Parasitic Element

(13) Ground Wiring Patterns

When using both small signal and large current GND patterns, it is recommended to isolate the two ground patterns, placing a single ground point at the application's reference point so that the pattern wiring resistance and voltage variations caused by large currents do not cause variations in the small signal ground voltage. Be careful not to change the GND wiring pattern potential of any external components, either.

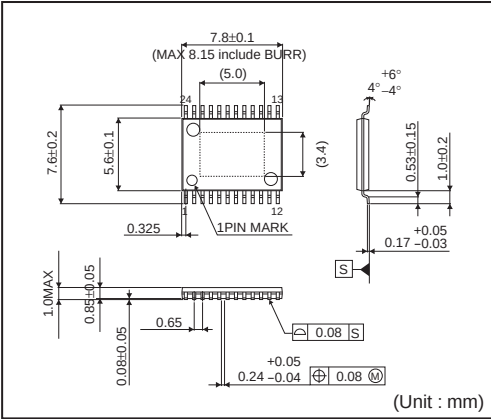
(14) TEST Terminal

Be sure to connect TEST pin to GND.

●Ordering part number

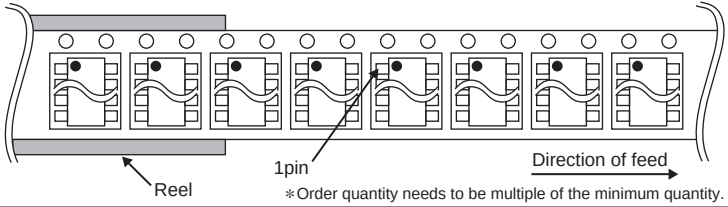
B D 6 3 9 4 0 E F V										-	E 2	
形名										パッケージ EFV=HTSSOP-B24		包装、フォーミング仕様 E2: リール状エンボステーピング

HTSSOP-B24



<Tape and Reel information>

Tape	Embossed carrier tape (with dry pack)
Quantity	2000pcs
Direction of feed	E2 (The direction is the 1pin of product is at the upper left when you hold reel on the left hand and you pull out the tape on the right hand)



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